AUTOMOTIVI GRADE

ROHS

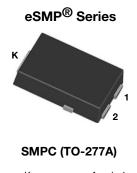
HALOGEN FREE



Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.60 \text{ V}$ at $I_F = 6 \text{ A}$



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	12 A			
V _{RRM}	200 V			
I _{FSM}	200 A			
V _F at I _F = 12 A (125 °C)	0.68 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V12P22	UNIT	
Device marking code		V1222		
Maximum repetitive peak reverse voltage	V_{RRM}	200	V	
Maximum DC forward current	I _{F(AV)} (1)	12	А	
	I _{F(AV)} (2)	3.2		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	200	А	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175		

Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended pad area
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 6 A	- T _J = 25 °C	V _F ⁽¹⁾	0.75	-	V
	I _F = 12 A			0.82	0.9	
	I _F = 6 A	- T _J = 125 °C		0.60	-	
	I _F = 12 A			0.68	0.76	
Reverse current	V _R = 160 V	T _J = 25 °C	I _R ⁽²⁾	0.0006	-	mA
	v _R = 100 v	T _J = 125 °C		1.5	1	
	V _R = 200 V	T _J = 25 °C		-	0.3	IIIA
	V _R = 200 V	T _J = 125 °C		3	12	
Typical junction capacitance	4.0 V, 1 MHz		CJ	720	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 5 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL V12P22			
Tuning the armed registers of	R _{0JA} (1)(2)	80	°C/W	
Typical thermal resistance	R _{eJM} (3)	4	C/VV	

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction-to-ambient
- $^{(3)}$ Mounted on 30 mm x 30 mm pad areas aluminum PCB, thermal resistance $R_{\theta JM}$ junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V12P22-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V12P22-M3/I	0.10	I	6500	13" diameter plastic tape and reel	
V12P22HM3_A/H (1)	0.10	Н	1500	7" diameter plastic tape and reel	
V12P22HM3_A/I (1)	0.10	ı	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

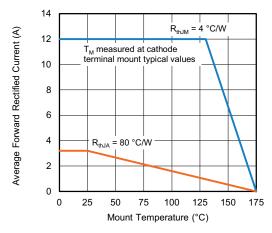


Fig. 1 - Maximum Forward Current Derating Curve

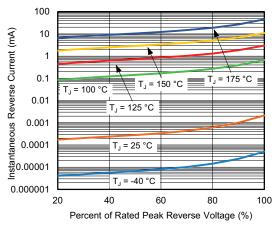


Fig. 4 - Typical Reverse Characteristics

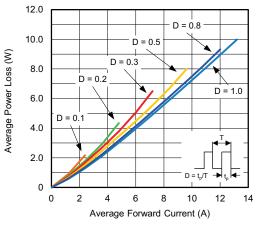


Fig. 2 - Forward Power Loss Characteristics

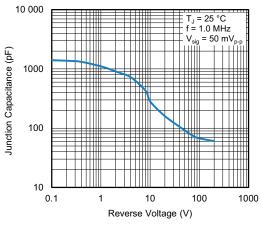


Fig. 5 - Typical Junction Capacitance

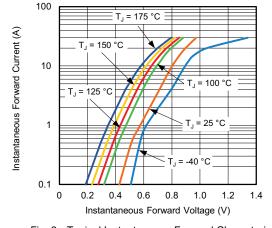


Fig. 3 - Typical Instantaneous Forward Characteristics

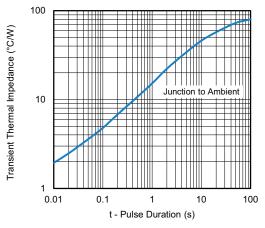
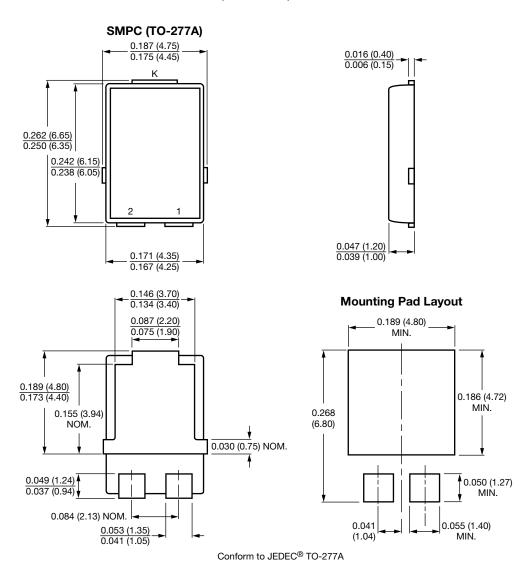


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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